

## HYBRID V.H.F./U.H.F. WIDE-BAND AMPLIFIER

Two-stage wide-band amplifier in the hybrid technique, designed for use in MATV systems, and as general purpose amplifier for v.h.f. and u.h.f. applications requiring a high output level. The OM323A needs an external collector-coil and blocking capacitor, whereas, the OM323 has these components built-in.

## QUICK REFERENCE DATA

Frequency range	$f$	40 to 860 MHz
Source and load (characteristic) impedance	$R_s = R_l = Z_0 =$	75 $\Omega$
Transducer gain	$G_{tr} =  s_f ^2$	typ 15 dB
Flatness of frequency response	$\pm \Delta  s_f ^2$	typ 0,5 dB
Output voltage at -60 dB intermodulation distortion (DIN45004, 3-tone); $f = 470$ MHz	$V_{O(rms)}$	typ 113 dB $\mu$ V
Noise figure	F	typ 9 dB
D.C. supply voltage	$V_B$	= 24 V $\pm$ 10%
Operating mounting-base temperature	$T_{mb}$	-30 to +100 $^{\circ}$ C

**ENCAPSULATION** 9-pin, in-line, resin-coated body on a right-angled metal mounting tab, see  
**MECHANICAL DATA**

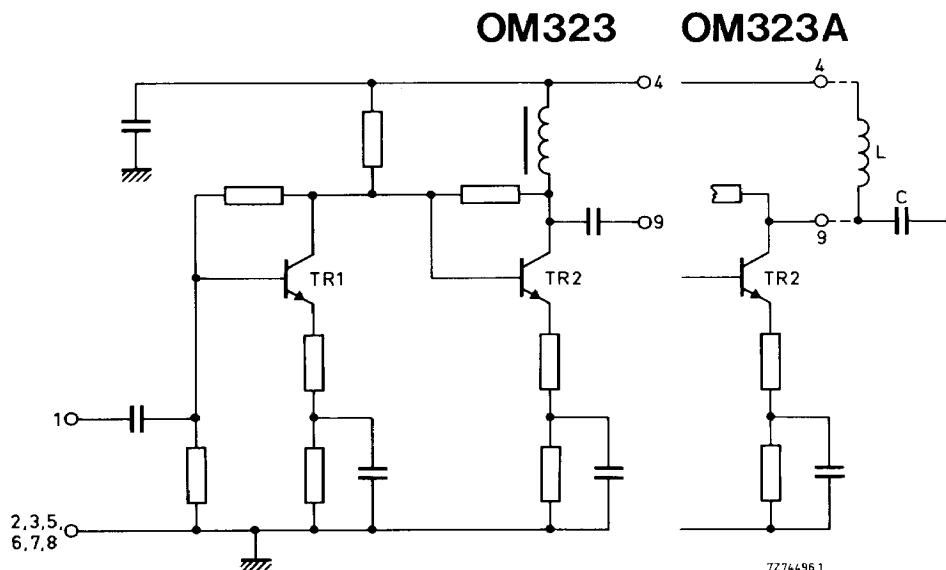


Fig. 1 Circuit diagram.

**RATINGS** Limiting values in accordance with the Absolute Maximum System (IEC134)

Operating mounting-base temperature	$T_{mb}$	—30 to +100 °C
Storage temperature	$T_{stg}$	—40 to +125 °C
D.C. supply voltage	$V_B$	max 28 V
Peak voltages on pin 1	$V_{1M}$	max 28 V
	$-V_{1M}$	max 24 V
Peak voltages on pin 9	$V_{9M}$	max 28 V
	$-V_{9M}$	max 4 V
Peak incident powers on pins 1 and 9	$P_{11M}, P_{19M}$	max 100 mW

**CHARACTERISTICS**

**Measuring conditions**

V.H.F.—U.H.F. test socket	catalogue no. 3504 110 01830 *
Mounting base temperature	$T_{mb}$ = 25 °C
D.C. supply voltage	$V_B$ = 24 V
Source impedance and load impedance	$R_s, R_l$ = 75 $\Omega$
Characteristic impedance of h.f. connections	$Z_0$ = 75 $\Omega$
Frequency range	$f$ = 40 to 860 MHz

**Performance**

Supply current	$I_B$	95 to 105 mA typ 100 mA
Transducer gain	$G_{tr} =  s_f ^2$	14 to 17 dB typ 15 dB
Flatness of frequency response	$\pm \Delta  s_f ^2$	typ 0,5 dB
Individual maximum v.s.w.r.		
input	$VSWR_{(i)}$	typ 1,9 **
output	$VSWR_{(o)}$	typ 2,3 **
Back attenuation		
$f = 100$ MHz	$ s_r ^2$	typ 29 dB
$f = 650$ MHz	$ s_r ^2$	typ 25,5 dB
$f = 860$ MHz	$ s_r ^2$	typ 24 dB

\* This socket can be made available for customer reference purposes.

\*\* Highest value, for a sample, occurring in the frequency range.

## Output voltage

at -60 dB intermodulation distortion

(DIN45004, par. 6.3: 3-tone)

f = 40–230 MHz

$V_{o(rms)}$	>	112 dB $\mu$ V
	typ	114 dB $\mu$ V

f = 470 MHz

$V_{o(rms)}$	typ	113 dB $\mu$ V
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f = 860 MHz

$V_{o(rms)}$	typ	112 dB $\mu$ V
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## Noise figure

channel 2

F	typ	8 dB
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channel 65

F	typ	9 dB
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s-parameters:	$s_f = s_{21}$	$s_i = s_{11}$
	$s_r = s_{12}$	$s_o = s_{22}$

## OPERATING CONDITIONS

Mounting-base temperature range

$T_{mb}$	-30 to +100 °C
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D.C. supply voltage

$V_B$	= 24 V $\pm$ 10%
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Frequency range

f	40 to 860 MHz
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Source impedance and load impedance

$R_s, R_L$	= 75 $\Omega$
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## THERMAL DATA

- The maximum permissible temperature at the mounting base is 100 °C.
- When the mounting tab is screwed to a double-sided printed-circuit board with dimensions 37 mm x 51 mm, its temperature will be 57 °C above the temperature of the surrounding free air.
- When a heatsink is fixed to the mounting tab and the pins are soldered into a double-sided printed-circuit board with dimensions 37 mm x 51 mm, the tab will reach the temperatures stated in the following table.

## Notes

- When the device is fixed only to a heatsink, not to a printed-circuit board, the values of the second column of the table should be increased by 2 °C and those of the third column decreased by 2 °C.
- The user is free to realize proper cooling by using differently shaped sinks, or, preferably, by fixing the tab to any convenient part of the equipment (e.g. a wall of the metal cabinet).

heatsink data thickness 1 mm	$T_{mb} - T_{amb}$ °C	$T_{amb\ max}$ °C
Bright aluminium heatsink		
L-shaped bar, length 100 mm, height 165 mm	24	76
Blackened aluminium heatsink		
L-shaped bar, length 50 mm, height 70 mm	23	77



**Mounting recommendations**

The module should preferably be mounted on a double-sided printed-circuit board, see the following example. An example is also given of heatsink mounting.

Input and output should be connected to 75  $\Omega$  tracks.

The connections to the common pins should be as close to the seating plane as possible.

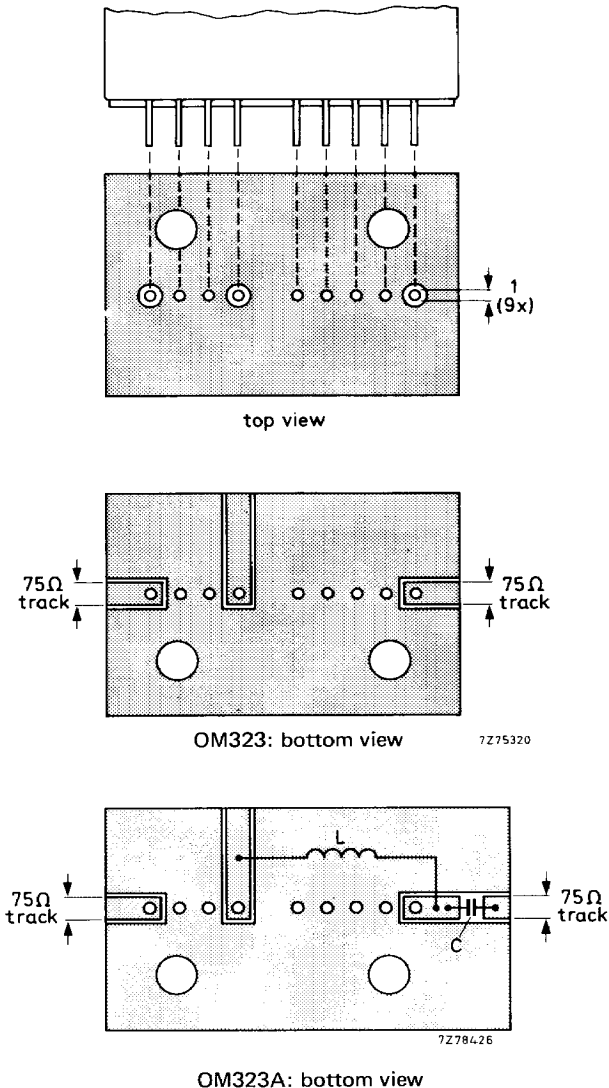


Fig. 3 Printed-circuit board holes and tracks for the OM323 and OM323A.

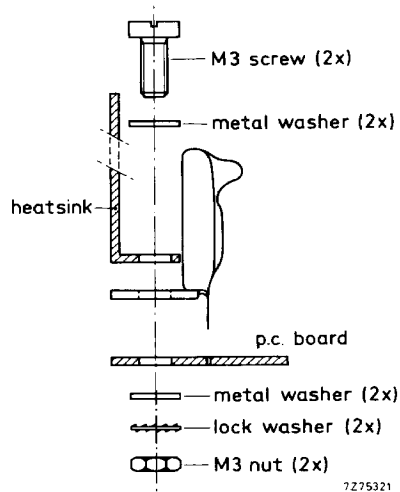


Fig. 4 Example of heatsink mounting.

$L > 5 \mu\text{H}$ ; e.g. catalogue no. 3122 108 20150 or 27 turns enamelled Cu wire (0,3 mm) wound on a ferrite core with a diameter of 1,6 mm.  
 $C > 220 \text{ pF}$  ceramic capacitor.